## **Electronic Supplementary Information**

## Unique Trapping of Paddlewheel Copper(II) Carboxylate by Ligand Bound {Cu<sub>2</sub>} Fragments for [Cu<sub>6</sub>] Assembly

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Scheme S1 Different bridging modes of carboxylates.



Scheme S2 Bridging carboxylate, hydroxido and perchlorido groups reported in this work.



Scheme S3 Synthesis of H<sub>3</sub>L.

Table S1 Crystal Data and Structure Refinement Details for Compounds  $1-3^a$ .

parameters	1	2	3
Formula	$C_{42}H_{70}Cl_4Cu_6N_8O_{33}$	C <sub>46</sub> H <sub>80</sub> Cl <sub>4</sub> Cu <sub>6</sub> N <sub>8</sub> O <sub>34</sub>	C <sub>66</sub> H <sub>88</sub> Cl <sub>4</sub> Cu <sub>6</sub> N <sub>8</sub> O <sub>34</sub>
F.W. (g mol <sup>-1</sup> )	1738.10	1812.22	2060.48
crystal system	Triclinic	monoclinic	monoclinic
space group	Pī	C2/c	C2/c
Crystal color	Green	Green	Green
Crystal size/mm <sup>3</sup>	0.30×0.24×0.15	0.31×0.26×0.15	0.32×0.25×0.17
a/ Å	10.1433(16)	22.6038(9)	30.454(6)
b/ Å	12.7099(19)	12.1267(5)	13.005(3)

c/ Å	14.230(2)	26.1807(11)	24.876(5)
α/ deg	115.462(4)	90.00	90.00
β/ deg	96.643(5)	99.4240(10)	114.482(6)
γ/ deg	104.762(4)	90.00	90.00
V/ Å <sup>3</sup>	1547.5(4)	7079.5(5)	8966(3)
Ζ	1	4	4
$D_c/\mathrm{g~cm^{-3}}$	1.865	1.700	1.526
$\mu$ (mm <sup>-1</sup> )	2.297	2.013	1.600
F(000)	884	3704	4216
<i>T</i> /K	100	295	295
Total reflns	19239	43821	44447
R(int)	0.0450	0.0762	0.0487
Unique reflns	5892	6924	7803
Observed reflns	4606	4294	5314
Parameters	420	439	525
$R_{I}; wR_{2} (I > 2\sigma(I))$	0.0464, 0.1213	0.0587, 0.1731	0.0800, 0.2579
$\operatorname{GOF}(F^2)$	1.077	1.020	1.101
Largest diff peak and hole (e $Å^{-3}$ )	1.301, -0.983	1.216, -0.471	1.598, -0.789
CCDC No.	1424792	1424793	1424794

 ${}^{a}R_{1} = \Sigma(||F_{o}| - |F_{c}||) / \Sigma|F_{o}|. wR_{2} = [\Sigma w(|F_{o}| - |F_{c}|)^{2} / \Sigma w(F_{o})^{2}]^{1/2}. w = 0.75 / (\sigma^{2}(F_{o}) + 0.0010F_{o}^{-2})$ 

Bond lengths (A)							
	Complex 1						
Cu1 – O1	1.954(3)	Cu2 – O1	1.950(3)	Cu3 – O4	2.149(3)		
Cu1 – O4	1.955(3)	Cu2 – O4	1.952(3)	Cu3 – O5	1.984(3)		
Cu1 – O7	2.586	Cu2 – O10	2.478	Cu3 – O6	1.970(3)		
Cu1 – O9	2.527	Cu2 – N3	1.922(4)	Cu3 – O7	1.979(3)		
Cu1 – N1	1.924(4)	Cu2 – N4	2.004(4)	Cu3 – O8	1.957(3)		
Cu1 – N2	2.007(4)	Cu1Cu2	2.9808(9)	Cu1Cu3	3.187		
Cu2Cu3	3.278	Cu3Cu3*	2.5577(12)				
Complex 2							
Cu1 – O1	1.956(4)	Cu2 – O1	1.953(4)	Cu3 – O4	2.153(4)		
Cu1 – O4	1.963(4)	Cu2 – O4	1.967(4)	Cu3 – O5	1.985(4)		
Cu1 – O5	2.514	Cu2 – O6	2.483	Cu3 – O6	1.989(4)		

Table S2 Selected bond distances (Å) and bond angles (°) in 1-3.

Cu1 – O11	2.679	Cu2 – O12	2.668	Cu3 – O7	1.948(4)
Cu1 – N1	1.923(5)	Cu2 – N3	1.917(5)	Cu3 – O8	1.944(4)
Cu1 – N2	2.005(5)	Cu2 – N4	2.021(5)	Cu1Cu3	3.239
Cu2Cu3	3.205	Cu3Cu3*	2.5401(14)	Cu1Cu2	2.9980(10)
		Com	plex 3		
Cu1 – O1	1.930(5)	Cu2 – O1	1.958(6)	Cu3 – O4	2.139(5)
Cu1 – O2	2.436(7)	Cu2 – O4	1.929(5)	Cu3 – O5	1.970(6)
Cu1 – O4	1.964(5)	Cu2 – O10	2.607	Cu3 – O6	1.983(5)
Cu1 – N1	1.929(8)	Cu2 – N3	1.917(8)	Cu3 – O7	1.941(6)
Cu1 – N2	2.008(7)	Cu2 – N4	2.009(9)	Cu3 – O8	1.986(5)
Cu1Cu2	2.9719(15)	Cu1Cu3	3.248	Cu2Cu3	3.3126
Cu3Cu3*	2.5781(18)				
		Bond a	ngles (°)		
		Com	plex 1		
O1-Cu1-O4	79.78(13)	N2-Cu1-O7	91.42	O4-Cu3-O6	97.61(13)
01–Cu1–O7	86.7	N2-Cu1-O9	97.05	O4–Cu3–O7	89.65(13)
O1-Cu1-O9	85.11	O1-Cu2-O4	79.92(13)	O4–Cu3–O8	99.84(13)
O1-Cu1-N1	91.99(15)	O1-Cu2-O10	91.52	O5-Cu3-O6	170.60(14)
O1-Cu1-N2	177.55(15)	01–Cu2–N3	91.26(15)	O5–Cu3–O7	90.37(14)
N1-Cu1-O4	169.00(16)	01–Cu2–N4	174.62(18)	O5-Cu3-O8	89.38(15)
N1-Cu1-O7	93.9	N3-Cu2-O4	170.49(15)	O6-Cu3-O7	87.25(14)
N1-Cu1-O9	97.97	N3-Cu2-O10	94.50	O6-Cu3-O8	91.48(14)
N1-Cu1-N2	86.56(16)	N3-Cu2-N4	86.72(18)	07–Cu3–O8	170.51(13)
O4–Cu1–O7	78.45	O4-Cu2-O10	89.34	Cu1–O1–Cu2	99.57(14)
O4-Cu1-O9	88.66	O4-Cu2-N4	101.74(16)	Cu1–O4–Cu2	99.44
O4-Cu1-N2	101.40(15)	N4-Cu2-O10	93.60	Cu1–O4–Cu3	101.81
O7–Cu1–O9	165.78	O4–Cu3–O5	91.46(13)	Cu1–O7–Cu3	87.51
Cu2-O4-Cu3	106.03				

Complex 2						
O1–Cu1–O4	80. 07(16)	O1-Cu2-O4	80. 05(16)	O4–Cu3–O5	86.71(16)	
O1–Cu1–O5	93.7	O1-Cu2-O6	92.5	O4-Cu3-O6	87.06(16)	
01-Cu1-O11	88.0	O1-Cu2-O12	87.6	O4–Cu3–O7	102.35(17)	
O1–Cu1–N1	91.6(2)	O1-Cu2-N3	91.6(2)	O4–Cu3–O8	101.88(16)	
O1-Cu1-N2	177.6(2)	O1-Cu2-N4	176.2(2)	O5-Cu3-O6	87. 67(18)	
N1-Cu1-O4	171.7(2)	N3-Cu2-O4	171.54(19)	O5-Cu3-O7	170.74(18)	
N1-Cu1-O5	103.5	N3-Cu2-O6	100.2	O5-Cu3-O8	91. 43(19)	
N1-Cu1-O11	92.4	N3-Cu2-O12	96.8	06–Cu3–O7	90.87(19)	
N1-Cu1-N2	86.1(2)	N3-Cu2-N4	85.7(2)	O6-Cu3-O8	170. 95(18)	
O4-Cu1-O5	77.8	O4-Cu2-O6	78.9	07–Cu3–O8	88.6(2)	
O4-Cu1-O11	86. 9	O4-Cu2-N4	102.74(19)	Cu1-O1-Cu2	100.13(18)	
O4-Cu1-N2	102.2(2)	O4-Cu2-O12	84.35	Cu1-O4-Cu2	99.43	
O5-Cu1-O11	164.0	N4-Cu2-O6	90.66	Cu1–O4–Cu3	103.73	
N2-Cu1-O5	86.3	N4-Cu2-O12	90.08	Cu1-O5-Cu3	91.35	
N2-Cu1-O11	92.6	O12-Cu2-O6	163.0	Cu2-O4-Cu3	102.07	
Cu2-O6-Cu3	90.88					
Complex 3						
O1–Cu1–O4	79.8(2)	O1-Cu2-O4	80.0(2)	O4–Cu3–O5	91.9(2)	
O1–Cu1–O2	106.6(2)	O1-Cu2-O10	84.3	O4–Cu3–O6	99.2(2)	
O1-Cu1-N1	92.1(3)	O1-Cu2-N3	91.4(3)	O4–Cu3–O7	98.5(2)	
O1-Cu1-N2	175.5(3)	O1-Cu2-N4	176.6(3)	O4-Cu3-O8	90.7(2)	
N1-Cu1-O4	165.5(3)	N3-Cu2-O4	166.0(3)	O5-Cu3-O6	88.7(2)	
N1-Cu1-O2	106.8(3)	N3-Cu2-O10	95.6	O5-Cu3-O7	169.6(2)	
N1-Cu1-N2	85.7(3)	N3-Cu2-N4	86.6(4)	O5-Cu3-O8	87.6(2)	
O4-Cu1-O2	87.2(2)	O4-Cu2-O10	94.5	O6-Cu3-O7	88.9(2)	
O4-Cu1-N2	101.5(3)	O4-Cu2-N4	102.5(3)	O6-Cu3-O8	169.6(2)	
O2-Cu1-N2	77.8(3)	O10-Cu2-N4	93.2	07–Cu3–O8	93.0(2)	

Cu1-O1-Cu2	99.7(3)	Cu1-O4-Cu2	99.5	



Scheme S4 Synthetic routes for 1-3 (Direct method A).



Scheme S5 Alternative path for Complex preparation (Method B).



**Fig. S1** Matching powder XRD patterns of **1-3** as synthesized (path B) and simulated patterns from the single crystal X-ray structures.



Fig. S2 Comparative FT-IR spectral patterns of 1-3.



Fig. S3 The Cu<sub>6</sub> parallelogram in 1 showing out of plane positioning of two Cu atoms.



Fig. S4 Intra- and inter-molecular hydrogen bonding in 1.							
Table S3 Hydrogen bonding parameters of complexes 1-3.							
Interactions	D-H (Å)	$D \cdots A(Å)$	H…A (Å)	D-H····A (°)			
Complex 1							
N2—H2…O2B	0.91	2.775	2.39	105			
N2—H2…O6	0.91	3.067	2.25	150			
O4—H40⋯O3	0.98	2.849	1.89	165			
O2A−H2A…O16	0.82	3.013	2.34	140			
O3−H30…O14	0.82	3.258	2.52	150			
N4—H4…O14	0.91	3.242	2.37	160			
Complex 2							
04 <b>-</b> H4…09	0.98	2.985	2.19	137			
O2−H2···O2w	0.82	3.125	2.36	155			
N2–H2A…O16B	0.91	3.154	2.27	164			
O3A−H3A…N4	0.82	2.859	2.52	106			
N4—H4A…O13B	0.91	3.264	2.50	142			
N4—H4A…O16A	0.91	3.463	2.56	171			
Complex 3							
N2—H2…O6	0.91	2.963	2.12	153			
O4−H4…O3	0.98	2.695	1.82	148			
O2−H2A…O9	0.82	2.964	2.31	137			
O2−H2A…O10	0.82	3.058	2.50	126			
N4—H40…O14	0.91	3.262	2.40	159			



Fig. S5 Core view of 1 showing (a) highly distorted octahedral coordination environment around Cu1 and Cu2, (b) square pyramidal coordination environment around Cu3, and (c) perchlorido group capped hexametallic  $\{Cu_6O_{12}\}$  unit.



Fig. S6 Core view of 3 showing (a) highly distorted octahedral coordination environment around Cu1 and Cu2, (b) square pyramidal coordination environment around Cu3, and (c) ligand alcohol arm and perchlorido group capped hexametallic { $Cu_6O_{12}$ } unit.



Fig. S7 *Intra*-molecular hydrogen bonding in 2 (left) and *intra*- and *inter*-molecular hydrogen bonding in 3(right).



Fig. S8 Variation inCu3···Cu3\* and Cu3–OH distances with respect to the pKa values of the carboxylic acids in 1, 2 and 3.



Fig. S9 Changes in molar susceptibility ( $\chi_M$ ) values with temperature for complexes 1-3 in zero field cooled-field cooled protocol (ZFC-FC) at 100 Oe magnetic fields.



Fig. S10 Variation of magnetization against magnetic field for 1 (a) and 2 (b) at different temperatures.



Fig. S11 Absorption spectra of  $I_3^-$  confirming the generation of  $H_2O_2$  in the system.

**Table S4** Comparison of  $k_{cat}$  vaules of complexes 1-3 and other known copper complexes.

Complex	Solvent	k <sub>cat</sub> in h <sup>-1</sup>	Ref
[Cu <sub>2</sub> (L)(µ-OH)(H <sub>2</sub> O)(ClO <sub>4</sub> ) <sub>2</sub> ]	DMSO	76	32b

[Cu <sub>2</sub> (L1)(μ-OAc)](ClO <sub>4</sub> ) <sub>2</sub> ·(CH <sub>3</sub> ) <sub>2</sub> CHOH	MeOH	90	32f
$[\{Cu_2L(\mu_{1,1}-N_3)(ClO_4)\}_2(\mu_{1,3}-N_3)_2]$	MeCN	215	32g
[Cu <sub>2</sub> (L2)( μ-OAc)](ClO <sub>4</sub> )·H <sub>2</sub> O·(CH <sub>3</sub> ) <sub>2</sub> CHOH	MeOH	183	32f
1	MeCN	202	Present work
2	MeCN	387	Present work
3	MeCN	185	Present work



Fig. S12 Electrospray mass spectrum (ESI +ve) of 1 in MeCN.



**Fig. S13** Electrospray mass spectrum (ESI +ve) of a 1/3,5-DTBC mixture (1:100) in MeCN and recorded within 5 min of mixing.



Fig. S14 Electrospray mass spectrum (ESI +ve) of 2 in MeCN.



**Fig. S15** Electrospray mass spectrum (ESI +ve) of a 1:100 **2**/3,5-DTBC mixture in MeCN and recorded within 5 min of mixing.



Fig. S16 Electrospray mass spectrum (ESI +ve) of 3 in MeCN.



**Fig. S17** Electrospray mass spectrum (ESI +ve) of a 1:100 **3**/3,5-DTBC mixture in MeCN and recorded within 5 min of mixing.



Fig. S18 Partially hydrolysed ligand (HL') in MeCN solution.



Fig. S19 Possible fragments of complex/catechol aggregates for 1 (a) and 2 (b) and 3(c).